N-channel 60 V, 1.8 Ω, 0.35 A, SOT23-3L, TO-92 STripFET™ Power MOSFET

Features

Туре	V _{DSS}	R _{DS(on)} max	I _D
2N7000	60 V	< 5 Ω(@10V)	0.35 A
2N7002	60 V	< 5 Ω(@10V)	0.20 A

- Low Q_g
- Low threshold drive

Application

■ Switching applications

Description

1050lete

This Power MOSFET is the second generation of STMicroelectronics unique "single feature size" strip-based process. The resulting transistor shows extremely high packing density for low onresistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

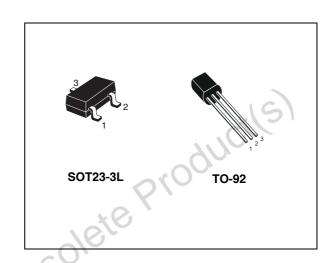


Figure 1. Internal schematic diagram

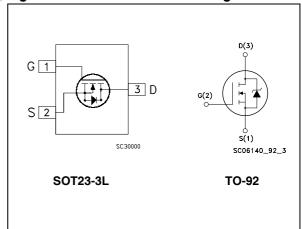


Table 1. Device summary

Order codes	Marking	Package	Packaging
2N7000	2N7000G	TO-92	Bulk
2N7002	ST2N	SOT23-3L	Tape and reel

Contents 2N7000, 2N7002

Contents

1	Electrical ratings
2	Electrical characteristics
3	Test circuits9
4	Package mechanical data
5	Revision history
0050	Electrical characteristics

2N7000, 2N7002 **Electrical ratings**

Electrical ratings 1

Table 2. **Absolute maximum ratings**

Symbol	Parameter	Va	Unit			
Symbol	Parameter	TO-92	SOT23-3L	Unit		
V_{DS}	Drain-source voltage (V _{GS} = 0)	6	V			
V _{DGR}	Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)	6	V			
V _{GS}	Gate- source voltage	±	٧			
I _D	Drain current (continuous) at T _C = 25 °C	0.35 0.20		Α		
I _{DM} ⁽¹⁾	Drain current (pulsed)	1.4 1		Α		
P _{TOT}	Total dissipation at $T_C = 25 ^{\circ}C$ 1 0.35		0.35	W		
Pulse width limited by safe operating area						
Table 3. Thermal data						
		\/-	duo			

^{1.} Pulse width limited by safe operating area

Table 3. Thermal data

Symbol	Parameter	Va	Unit	
Symbol	Parameter	TO-92	SOT23-3L	Ullit
Rthj-amb	Thermal resistance junction-ambient max	125	357.1 ⁽¹⁾	°C/W
T _J	Operating junction temperature	55 to 150		°C
T _{stg}	Storage temperature	- 55 (- 55 to 150	

[.]ed on 1i 1. When mounted on 1inch² FR-4, 2 Oz copper board.

Electrical characteristics 2N7000, 2N7002

2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified)

Table 4. On/off states

Symbol	Parameter	Parameter Test conditions		Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 250 μA, V _{GS} =0	60			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V_{DS} = max rating V_{DS} = max rating, T_{C} = 125 °C			1 10	μ Α μ Α
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 18 V		ZU	±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$.1C	2.1	3	V
R _{DS(on)}	Static drain-source on resistance	$V_{GS} = 10 \text{ V}, I_D = 0.5 \text{ A}$ $V_{GS} = 4.5 \text{ V}, I_D = 0.5 \text{ A}$		1.8 2	5 5.3	Ω

Table 5. Dynamic

	Symbol Parameter		Test conditions	Min.	Тур.	Max.	Unit
	9 _{fs} ⁽¹⁾	Forward transconductance	$V_{DS} = 10 \text{ V}, I_{D} = 0.5 \text{ A}$		0.6		S
	C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	V _{DS} = 25 V, f = 1 MHz, V _{GS} = 0		43 20 6		pF pF pF
. 0	t _{d(on)} t _r t _{d(off)} t _f	Turn-on delay time Rise time Turn-off delay time Fall time	V_{DD} = 30 V, I_D = 0.5 A R_G = 4.7 Ω V_{GS} = 4.5 V (see <i>Figure 16</i>)		5 15 7 8		ns ns ns
Obsor	Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	$V_{DD} = 30 \text{ V}, I_D = 1 \text{ A},$ $V_{GS} = 5 \text{ V}$ (see <i>Figure 17</i>)		1.4 0.8 0.5	2	nC nC nC

^{1.} Pulsed: Pulse duration = 300 μs, duty cycle 1.5%.

2N7000, 2N7002 **Electrical characteristics**

Table 6. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current Source-drain current (pulsed)				0.35 1.40	A A
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 1 A, V _{GS} = 0			1.2	V
t _{rr}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 1 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s,}$ $V_{DD} = 20 \text{ V, T}_j = 150 ^{\circ}\text{C}$ (see <i>Figure 18</i>)		32 25 1.6		ns nC A
IRRM	Heverse recovery current	(See Figure 18)		1.0		А
1. Pulse wid	oth limited by safe operating are	a.				
2. Puised: F	ruise duration = 300 µs, duty cy	CIE 1.5%			11:)
		(see Figure 18) a. cle 1.5%		1.1		
				$Q_{\mathcal{N}}$		
			$\gamma \epsilon^{C}$)		
		40	-			
		78,				
		60,				
		003				
		O F				
	.(5)					
	CIL					
	AUI					
	(O)					
0						
W.C.						
O.LO						

Electrical characteristics 2N7000, 2N7002

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area for TO-92

Figure 3. Thermal impedance for TO-92

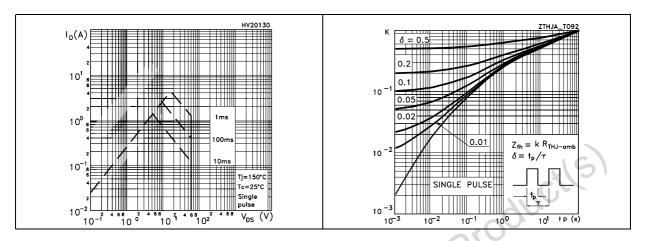


Figure 4. Safe operating area for SOT23-3L

Figure 5. Thermal impedance for SOT23-3L

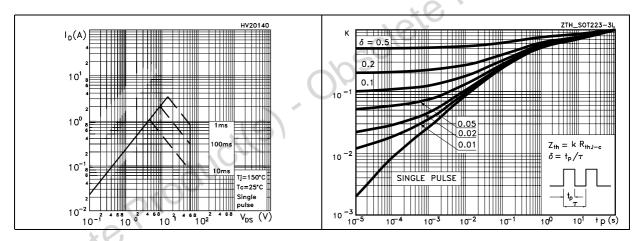


Figure 6. Output characteristics

Figure 7. Transfer characteristics

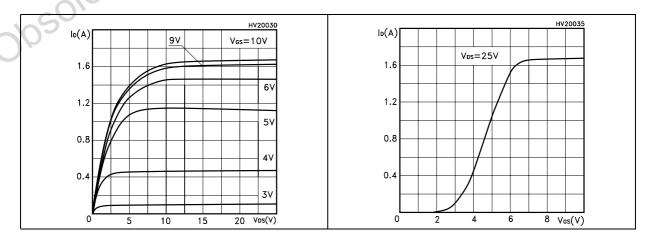


Figure 8. Transconductance

Figure 9. Static drain-source on resistance

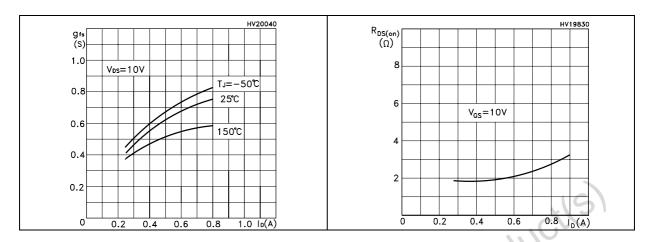


Figure 10. Gate charge vs gate-source voltage Figure 11. Capacitance variations

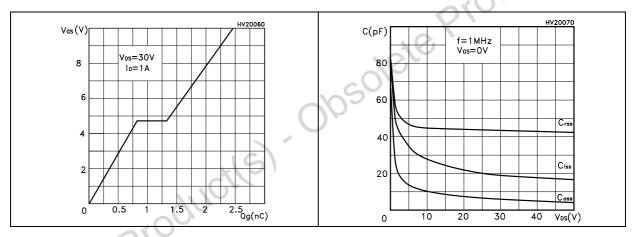
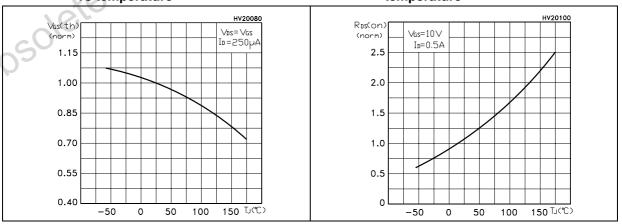


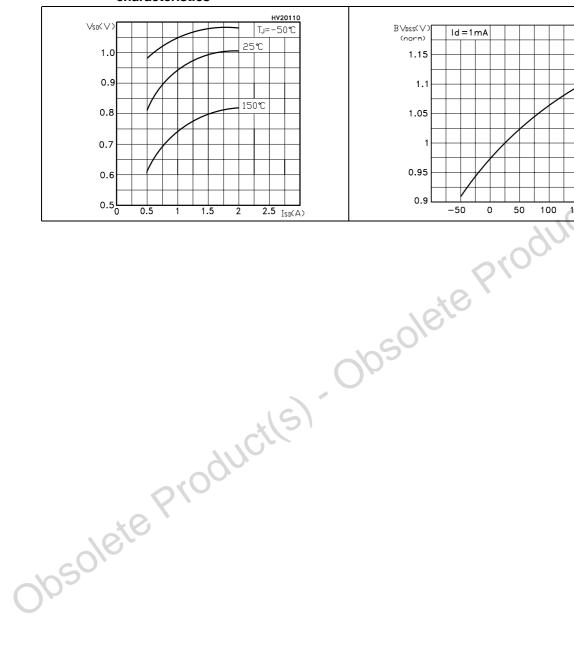
Figure 12. Normalized gate threshold voltage Figure 13. Normalized on resistance vs vs temperature temperature

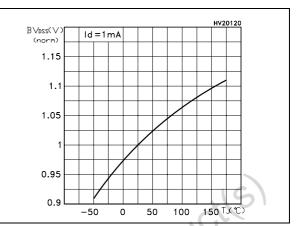


Electrical characteristics 2N7000, 2N7002

Figure 14. Source-drain diode forward characteristics

Figure 15. Normalized B_{VDSS} vs temperature





2N7000, 2N7002 Test circuits

3 Test circuits

Figure 16. Switching times test circuit for resistive load

Figure 17. Gate charge test circuit

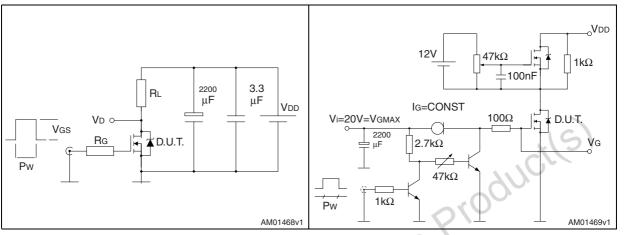


Figure 18. Test circuit for inductive load switching and diode recovery times

Figure 19. Unclamped Inductive load test circuit

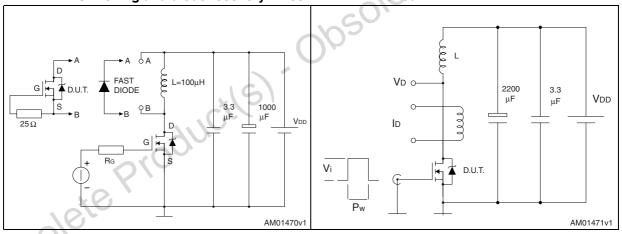
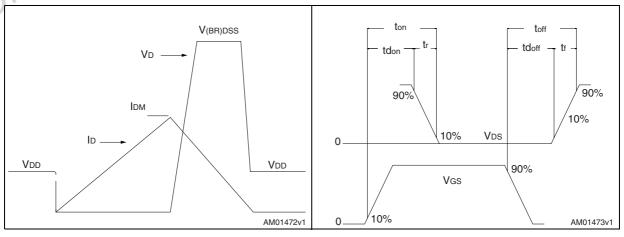


Figure 20. Unclamped inductive waveform

Figure 21. Switching time waveform



10/14

4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

Obsolete Product(s). Obsolete Product(s)

Table 7. TO-92 mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
Α	4.32		4.95
b	0.36		0.51
D	4.45		4.95
E	3.30		3.94
е	2.41		2.67
e1	1.14		1.40
L	12.70		15.49
R	2.16		2.41
S1	0.92		1.52
W	0.41	O,	0.56
V		5°	

Figure 22. TO-92 drawing

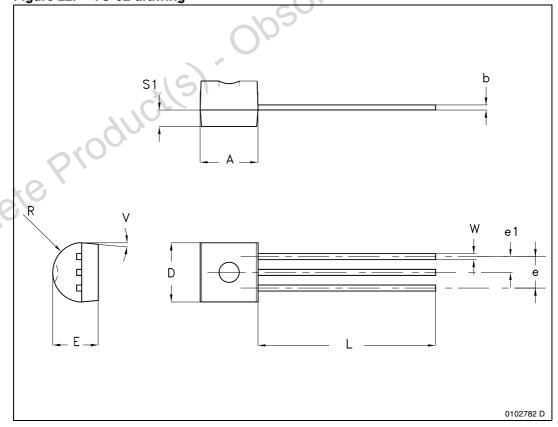
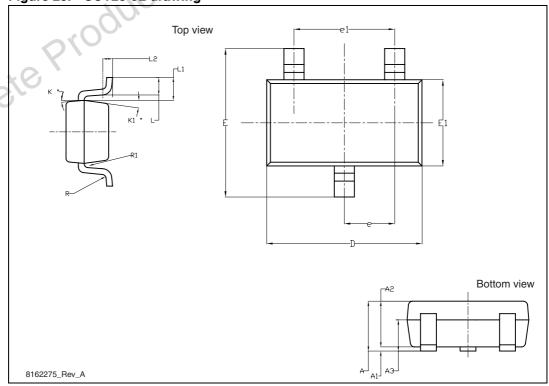


Table 8. SOT23-3L mechanical data

Dim.		mm	
Dilli.	Min.	Тур.	Max.
Α			1.25
A1	0		0.15
A2	1.00		1.20
A3	0.60		0.70
D	2.826		3.026
Е	2.60		3.00
E1	1.526		1.726
е		0.95	11/0
e1		1.90	00.
L	0.35	0	0.60
L1		0.59	
L2		0.25	
R	0.05	60,	
R1	0.05	102	0.20
K	3°	/	7°
K1	6°		10°

Figure 23. SOT23-3L drawing



2N7000, 2N7002 Revision history

5 Revision history

Table 9. Document revision history

	Date	Revision	Changes			
	09-Oct-2004	1	First document			
	22-Jun-2004	2	Complete document			
	06-Apr-2005	3	New typ and max value inserted for Vgs(th)			
	19-Apr-2005	4	The document has been reformatted			
	26-Apr-2005	5	New Pin configuration for TO-92			
	28-Apr-2005	6	Pin configuration change again			
	19-Jun-2006	7	New template, no content change			
	03-Sep-2007	8	Corrected marking on first page			
	04-Nov-2008	9	 Updated Table 7: TO-92 mechanical data and Figure 22: TO-92 drawing. Updated Table 8: SOT23-3L mechanical data and Figure 23: SOT23-3L drawing. 			
Obsolete Product(s) - Obso,						

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